

STGD5NB120SZ

5 A - 1200 V - low drop internally clamped IGBT

Features

- Low on-voltage drop (V_{CE(sat)})
- High current capability
- Off losses include tail current
- High voltage clamping

Applications

- Light dimmer
- Inrush current limitation
- Pre-heating for electronic lamp ballast

Description

This IGBT utilizes the advanced Power MESH™ process resulting in an excellent trade-off between switching performance and low on-state behavior.

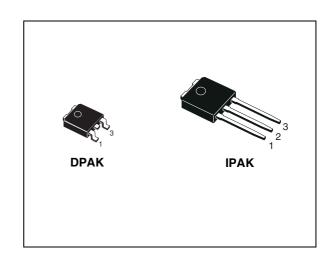


Figure 1. Internal schematic diagram

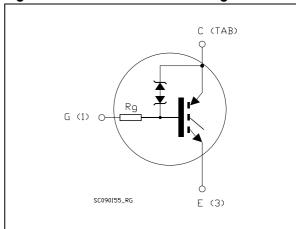


Table 1. Device summary

| Order codes | Marking | Package | Packaging |
|----------------|------------|---------|---------------|
| STGD5NB120SZ-1 | GD5NB120SZ | IPAK | Tube |
| STGD5NB120SZT4 | GD5NB120SZ | DPAK | Tape and reel |

Contents STGD5NB120SZ

Contents

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STGD5NB120SZ Electrical ratings

1 Electrical ratings

Table 2. Absolute maximum ratings

| Symbol | Parameter | Value | Unit |
|--------------------------------|---|-------------|------|
| V _{CES} | Collector-emitter voltage (V _{GE} = 0) | 1200 | ٧ |
| I _C ⁽¹⁾ | Collector current (continuous) at T _C = 25 °C | 10 | Α |
| I _C ⁽¹⁾ | Collector current (continuous) at T _C = 100 °C | 5 | Α |
| I _{CP} ⁽²⁾ | Pulsed collector current | 10 | Α |
| I _{CL} ⁽³⁾ | Turn-off latching current | 10 | Α |
| V _{GE} | Gate-emitter voltage | ±20 | V |
| V _{ECR} | Emitter-collector voltage | 20 | ٧ |
| E _{AS} (4) | Single pulse avalanche energy at T _C = 25 °C | 10 | mJ |
| L'AS ` | Single pulse avalanche energy at T _C = 100 °C | 7 | mJ |
| P _{TOT} | Total dissipation at T _C = 25 °C | 75 | W |
| T _j | Operating junction temperature | – 55 to 150 | °C |

^{1.} Calculated according to the iterative formula:

$$I_{C}(T_{C}) = \frac{T_{j(max)} - T_{C}}{R_{thj-c} \times V_{CE(sat)(max)}(T_{j(max)}, I_{C}(T_{C}))}$$

- 2. Pulse width limited by max. temperature allowed
- 3. V_{CLAMP} = 80% (V_{CES}), V_{GE} = 15 V, R_{G} = 10 Ω , T_{J} = 150 °C
- 4. $V_{CE} = 50 \text{ V}$, $I_{AV} = 3.3 \text{ A}$

Table 3. Thermal resistance

| Symbol | Symbol Parameter | | Unit |
|-----------------------|---|------|------|
| R _{thj-case} | Thermal resistance junction-case IGBT max | 1.67 | °C/W |
| R _{thj-amb} | Thermal resistance junction-ambient max | 100 | °C/W |

Electrical characteristics STGD5NB120SZ

2 Electrical characteristics

(T_{CASE}=25 $^{\circ}\text{C}$ unless otherwise specified)

Table 4. Static electrical characteristics

| Symbol | Parameter | Test conditions | Min. | Тур. | Max. | Unit |
|----------------------|---|--|------|------------|-----------|--------------------------|
| V _{(BR)CES} | Collector-emitter breakdown voltage (V _{GE} = 0) | I _C = 10 mA | 1200 | | | V |
| V _{CE(sat)} | Collector-emitter saturation voltage | V _{GE} = 15 V, I _C = 5 A V _{GE} = 15 V, I _C = 5 A,T _C = 125 °C | | 1.3 1.2 | 2.0 | V V |
| V _{GE(th)} | Gate threshold voltage | $V_{CE} = V_{GE}$, $I_{C} = 250 \mu A$ | 2 | | 5 | V |
| V _{GE} | Gate emitter voltage | V_{CE} = 2.5 V, I_{C} = 2 A, T_{C} = 25 ÷ 125 °C | | | 6.5 | ٧ |
| I _{CES} | Collector cut-off current (V _{GE} = 0) | V _{CE} = 900 V V _{CE} = 900 VT _C = 125 °C | | | 50 250 | μ Α μ Α |
| I _{GES} | Gate-emitter leakage current (V _{CE} = 0) | V _{GE} = ±20 V | | | ±100 | nA |
| 9 _{fs} | Forward transconductance | $V_{CE} = 15 V_{,} I_{C} = 5 A$ | | 5 | | S |
| R_{G} | Gate resistance | | | 4 | | kΩ |

Table 5. Dynamic electrical characteristics

| Symbol | Parameter | Test conditions | Min. | Тур. | Max. | Unit |
|--|---|---|------|----------------|------|----------------|
| C _{ies} C _{oes} C _{res} | Input capacitance Output capacitance Reverse transfer capacitance | V _{CE} = 25 V, f = 1 MHz, V _{GE} = 0 | | 430 40 7 | | pF pF pF |

Table 6. Switching on/off (inductive load)

| Symbol | Parameter | Test conditions | Min. | Тур. | Max. | Unit |
|--|---|---|------|--------------------------|------|----------------------|
| t _{d(on)} t _r (di/dt) _{on} | Turn-on delay time Current rise time Turn-on current slope | V_{CC} = 960 V, I_{C} = 5A R_{drive} = 1 k Ω , V_{GE} = 15 V, (see Figure 18) | | 690 170 39.6 | | ns ns A/µs |
| t _{d(on)} t _r (di/dt) _{on} | Turn-on delay time Current rise time Turn-on current slope | V_{CC} = 960 V, I_{C} = 5A R_{drive} = 1 k Ω , V_{GE} = 15 V T_{C} = 125 °C (see Figure 18) | | 600 185 39 | | ns ns A/µs |
| $\begin{array}{c} t_{\rm c} \\ t_{\rm r}({\rm V}_{\rm off}) \\ t_{\rm d}(_{\rm off}) \\ t_{\rm f} \end{array}$ | Cross-over time Off voltage rise time Turn-off delay time Current fall time | V_{CC} = 960 V, I_{C} = 5A R_{drive} = 1 k Ω , V_{GE} = 15 V (see Figure 18) | | 4 2.2 12.1 1.13 | | μs μs μs μs |
| $\begin{array}{c} t_{\rm c} \\ t_{\rm r}({\rm V}_{\rm off}) \\ t_{\rm d}(_{\rm off}) \\ t_{\rm f} \end{array}$ | Cross-over time Off voltage rise time Turn-off delay time Current fall time | V_{CC} = 960 V, I_{C} = 5A R_{drive} = 1 k Ω , V_{GE} = 15 V, T_{C} = 125 °C (see Figure 18) | | 5 2.2 12.1 2 | | μs μs μs μs |

Table 7. Switching energy (inductive load)

| Symbol | Parameter | Test conditions | Min. | Тур. | Max. | Unit |
|--|---|---|------|-----------------------|------|----------------|
| E _{on} ⁽¹⁾ E _{off} ⁽²⁾ E _{ts} | Turn-on switching losses Turn-off switching losses Total switching losses | V_{CC} = 960 V, I_{C} = 5A R_{drive} = 1 k Ω , V_{GE} = 15 V (see Figure 18) | | 2.59 9 11.59 | | mJ mJ mJ |
| E _{on} ⁽¹⁾ E _{off} ⁽²⁾ E _{ts} | Turn-on switching losses Turn-off switching losses Total switching losses | V_{CC} = 960 V, I_{C} = 5A R_{drive} = 1 k Ω , V_{GE} = 15 V, T_{C} = 125 °C (see Figure 18) | | 2.64 10.2 12.68 | | mJ mJ mJ |

Eon is the turn-on losses when a typical diode is used in the test circuit in (see Figure 18). If the IGBT is
offered in a package with a co-pak diode, the co-pack diode is used as external diode. IGBTs & Diode are
at the same temperature (25°C and 125°C)

Table 8. Functional test

| Symbol | Parameter | Test conditions | Min. | Тур. | Max. | Unit |
|-----------------|---------------------------------------|--|------|------|------|------|
| I _{AS} | Unclamped inductive switching current | V_{CC} = 50 V, L = 1.8 mH T_{start} = 25 °C, R_{drive} = 1 k Ω | 3.3 | | | А |

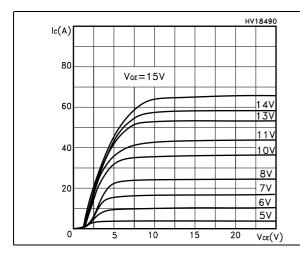
^{2.} Turn-off losses include also the tail of the collector current

Electrical characteristics STGD5NB120SZ

2.1 Electrical characteristics (curves)

Figure 2. Output characteristics

Figure 3. Transfer characteristics



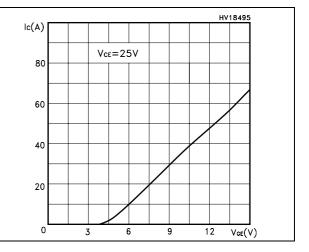
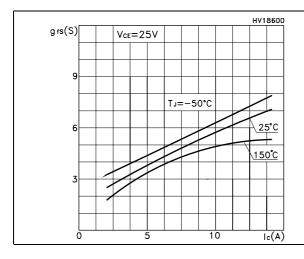


Figure 4. Transconductance

Figure 5. Collector-emitter on voltage vs temperature



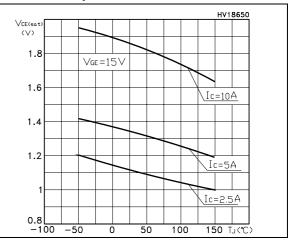
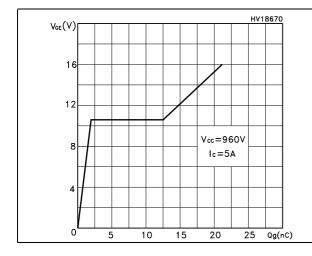
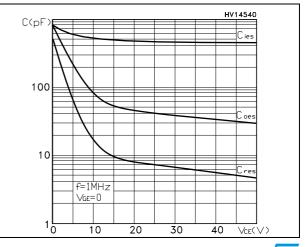


Figure 6. Gate charge vs gate-source voltage Figure 7. Capacitance variations





6/15

HV18630 HV18620 V_{GE}(th) VCE(SAT) $\bigvee_{CE} = \bigvee_{GE}$ (V) Ic=250µA 1.02 VGE=15V 2.2 0.98 1.8 TJ=150°C 0.96 1.4 -50°C 0.94 0.92 0.6 100 -5050 150 TJ(℃) 6 9 12 15 Ic(A)

Figure 8. Normalized gate threshold voltage Figure 9. Collector-emitter on voltage vs vs temperature collector current

Figure 10. Breakdown voltage vs temperature Figure 11. Normalized collector-emitter on voltage vs temperature

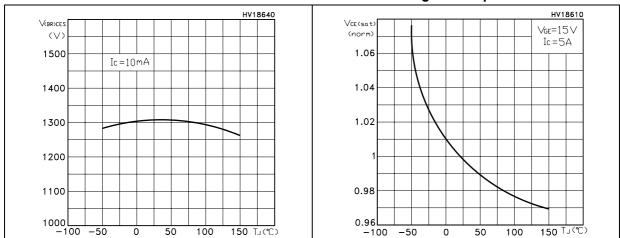
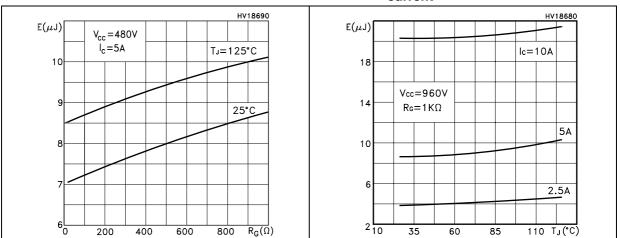


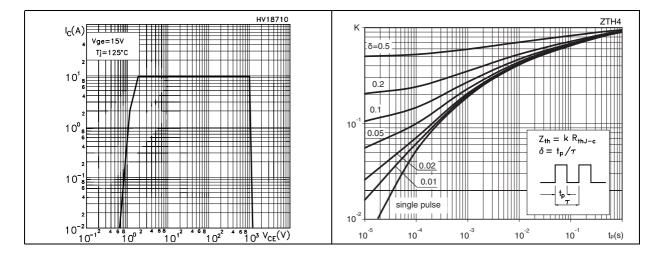
Figure 12. Switching losses vs gate resistance Figure 13. Switching losses vs collector current



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Figure 14. Turn-off SOA

Figure 15. Thermal impedance



STGD5NB120SZ Test circuit

3 Test circuit

Figure 16. Test circuit for inductive load switching

Figure 17. Gate charge test circuit

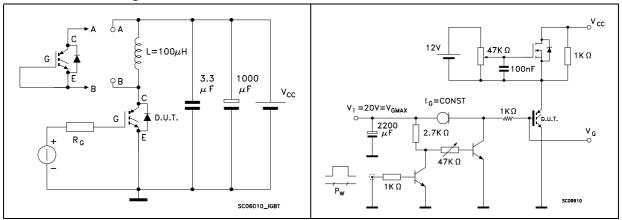
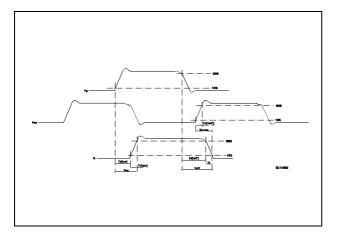


Figure 18. Switching waveform

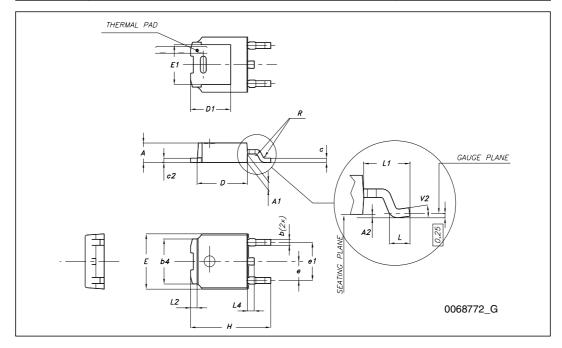


4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

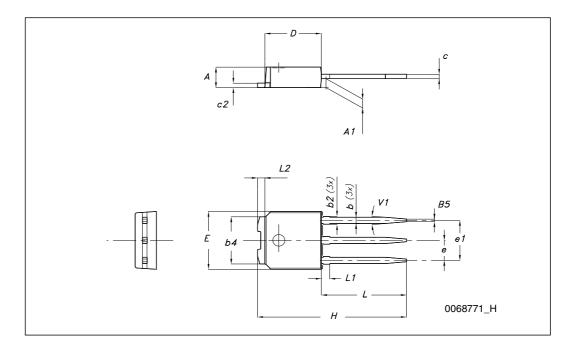
TO-252 (DPAK) mechanical data

| DIM. | | mm. | |
|-------|------|------|-------|
| DIWI. | min. | typ | max. |
| A | 2.20 | | 2.40 |
| A1 | 0.90 | | 1.10 |
| A2 | 0.03 | | 0.23 |
| b | 0.64 | | 0.90 |
| b4 | 5.20 | | 5.40 |
| С | 0.45 | | 0.60 |
| c2 | 0.48 | | 0.60 |
| D | 6.00 | | 6.20 |
| D1 | | 5.10 | |
| E | 6.40 | | 6.60 |
| E1 | | 4.70 | |
| е | | 2.28 | |
| e1 | 4.40 | | 4.60 |
| Н | 9.35 | | 10.10 |
| L | 1 | | |
| L1 | | 2.80 | |
| L2 | | 0.80 | |
| L4 | 0.60 | | 1 |
| R | | 0.20 | |
| V2 | 0 ° | | 8 ° |



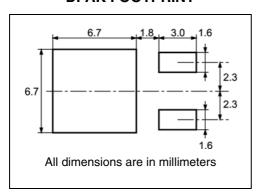
| TO-251 (| IPAK) | mechanical | data |
|----------|-------|------------|------|
|----------|-------|------------|------|

| DIM. | mm. | | |
|-------|------|-------|------|
| DIWI. | min. | typ | max. |
| Α | 2.20 | | 2.40 |
| A1 | 0.90 | | 1.10 |
| b | 0.64 | | 0.90 |
| b2 | | | 0.95 |
| b4 | 5.20 | | 5.40 |
| С | 0.45 | | 0.60 |
| c2 | 0.48 | | 0.60 |
| D | 6.00 | | 6.20 |
| E | 6.40 | | 6.60 |
| е | | 2.28 | |
| e1 | 4.40 | | 4.60 |
| Н | | 16.10 | |
| L | 9.00 | | 9.40 |
| (L1) | 0.80 | | 1.20 |
| L2 | | 0.80 | |
| V1 | | 10 ° | |

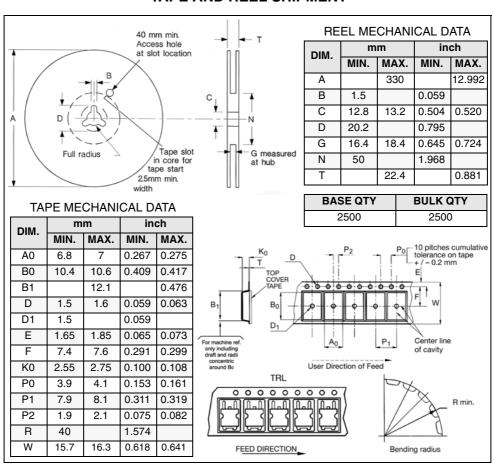


5 Packaging mechanical data

DPAK FOOTPRINT



TAPE AND REEL SHIPMENT



Revision history STGD5NB120SZ

6 Revision history

Table 9. Document revision history

| Date | Revision | Changes |
|-------------|----------|---|
| 06-Oct-2003 | 5 | No history because migration |
| 18-Jan-2005 | 6 | Final datasheet |
| 13-Nov-2008 | 7 | Insert new value in Table 2: Absolute maximum ratings |

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